

Product Compliance Declaration

Please see www.molex.com for the most up-to-date information.

Contact Information

Name Molex Product Compliance E-Mail Product.Compliance@molex.com

Part Information

Part Number 0014562082 Part Weight 1.215687G

Part Name CGrid SL IDT Opt G 15"SAu 8Ckt

Product Composition

Name	Туре	CAS Number	Proportion (% Total)	Mass (Grams)	
CGrid SL IDT Opt G 15"SAu 8Ckt	Assembly		100	1.215687	
SL Female IDT Term 15"SAu Formed	Assembly		53.9355	0.655687	
SL Female IDT Term 15"SAu	Assembly		53.9355	0.655687	
SL Term Blanked	Component		50.6709	0.616	
Phosphor Bronze 5% Unplated	Material		50.6709	0.616	
Copper	Substance	7440-50-8	48.0614	0.584276	
Tin	Substance	7440-31-5	2.5335	0.0308	
Phosphorus	Substance	7723-14-0	0.076	0.000924	
Gold Plating	Material		0.0401	0.000487	
Cobalt	Substance	7440-48-4	0.0001	0.000001	
Nickel	Substance	7440-02-0	0.0001	0.000001	
Gold	Substance	7440-57-5	0.0399	0.000485	
Nickel Plating	Material		1.5794	0.0192	

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Name	Туре	CAS Number	Proportion (% Total)	Mass (Grams)	
Nickel	Substance	7440-02-0	1.5792	0.019198	
Further Additives, not to declare	Substance	system	0.0002	0.000002	
Tin Plating	Material		1.6452	0.02	
Tin	Substance	7440-31-5	1.6452	0.02	
SL 8Ckt 700660182 Opt G	Component		46.0645	0.56	
PBT+PC GF BLACK	Material		46.0645	0.56	
PC+PBT	Substance		23.9936	0.291687	
GF-Fibre	Substance		15.2213	0.185044	
Flame Retardant, ISO 1043-4 FR(17)	Substance		4.2459	0.051617	
Antimonytrioxide	Substance	1309-64-4	1.4821	0.018017	
Pigment portion, not to declare	Substance	system	0.5608	0.006817	
Further Additives, not to declare	Substance	system	0.5608	0.006817	

ROHS Declaration Information

Regulatory Revision EU 2015/863

Compliance Status Compliant

Contained Substances Exceeding Threshold

None

Exemptions

None

REACH-SVHC Declaration Information

Regulatory Revision D(2020)4578-DC (25 June 2020)

Contained Substances Exceeding Threshold

None

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GADSL Declaration Information

Regulatory Revision GADSL imported from IMDS

Contained Substances Exceeding Threshold

Substance Group	Substance Location	Threshold (PPM)	Concentration (PPM)	Intentionally Added
lead	e-plate Sn (electrodeposited Tin Coatings, bright and matt)	*Note	500	Yes
lead	Phosphor Bronze 5% A (CA510)	*Note	*Note 250	
Antimonytrioxide	PBT+PC GF BLACK	*Note	40,000	Yes
nickel powder [particle diameter < 1 mm]	e-plate Au (Hardgold) (electrodeposited Hardgold	*Note	2,500	Yes
nickel powder [particle diameter < 1 mm]	Ep-Ni	*Note	997,500	Yes
Cobalt	e-plate Au (Hardgold) (electrodeposited Hardgold	*Note	2,500	Yes
copper	Phosphor Bronze 5% A (CA510)	A (CA510) *Note 943,350		Yes
glass, oxide, chemicals	PBT+PC GF BLACK	*Note	350,000	Yes

^{*}Note: For GADSL substance declarable/prohibited threshold values, please reference http://www.gadsl.org/

Exemptions

Part Name	Exemption		
e-plate Sn (electrodeposited Tin Coatings, bright and matt)	44 Concentration within acceptable GADSL limits		
Phosphor Bronze 5% A (CA510)	44 Concentration within acceptable GADSL limits		
e-plate Au (Hardgold) (electrodeposited Hardgold Coatings)	34 Not applicable		
Ep-Ni	33 Other application (Surface not routinely touched or nickel release rate < 0.5µg/cm2/week)		

HFLH Declaration Information

Regulatory Revision IEC 61249-2-21

Contained Substances Exceeding Threshold

Substance Group	Substance Location	Threshold (PPM)	Concentration (PPM)	Intentionally Added
Bromine and its compounds	PBT+PC GF BLACK	900	100,000	Yes
Bromine and Chlorine combined	PBT+PC GF BLACK	1,500	100,000	Yes

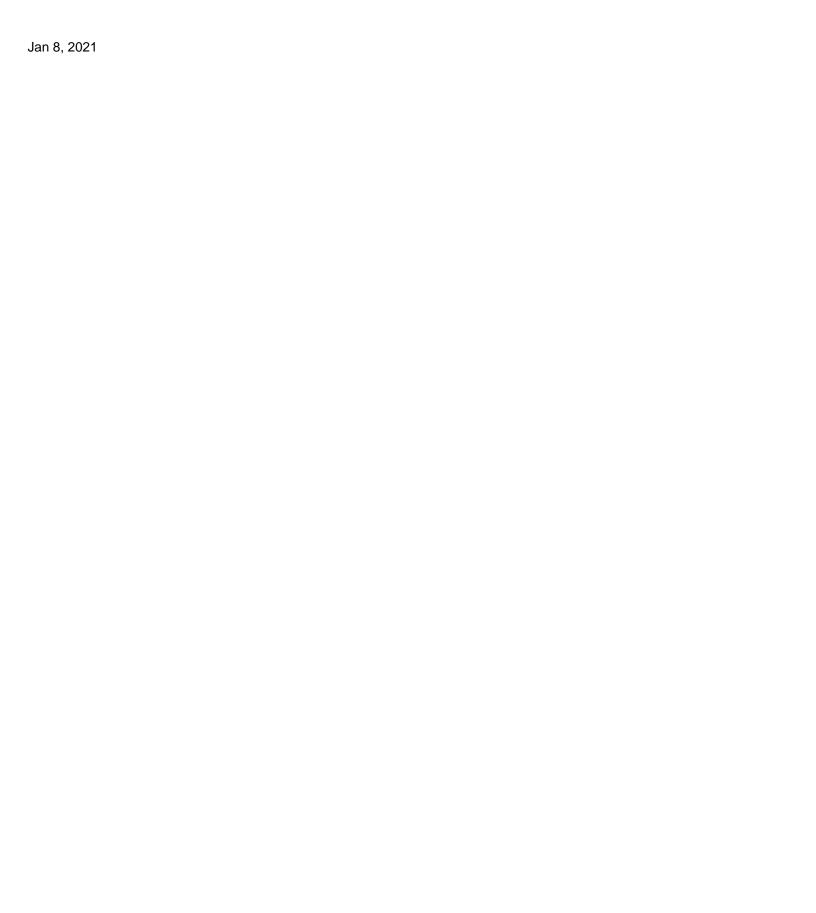
China ROHS Declaration Information

Part Number 0014562082							
Part Name CGrid SL IDT Opt G 15"SAu 8Ckt	€						
Part Information			Haz	zardous S	Substance	es	
Components		Lead	Mercury	Cadmium	Hex. Chromium	PBB	PBDE
CGrid SL IDT Opt G 15"SAu 8Ckt		0	0	0	0	0	0
SL Female IDT Term 15"SAu Formed		0	0	0	0	0	0
SL Female IDT Term 15"SAu		0	0	0	0	0	0
SL Term Blanked		0	0	0	0	0	0
SL 8Ckt 700660182 Opt G		0	0	0	0	0	0

Process Information

Component Plating / Surface Finish	N/A
Termination Base Alloy	P-Bronze
Solder Alloy	N/A
Process Capability	N/A
Maximum Exposure Time (seconds)	N/A
Maximum Process Temperature (C)	N/A
Maximum Cycles at Reflow Temperature	N/A
J-STD-020 Moisture Sensitivity Level	N/A

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